

Bruker BioSpin

# **BLAH500 E** •

Amplifier 500-600MHz INR OUTR Operating & Service Manual

Version 001

NMR Spectroscopy

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This unit is not designed for any type of use which is not specifically described in this manual. Such use may be hazardous.

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# General Information

Introduction 1.1

The BLAH500 E Amplifier 500-600MHz INR OUTR is a broadband linear pulse power amplifier specifically designed for Nuclear Magnetic Resonance (NMR) application for 11,7 to 14,1 Teslas Systems. It is commercialized under the BRUKER BIOSPIN part number W1345527.

It is operated in AB linear class and provides 500W and more peak RF power over the frequency range 470-600MHz on the 500W channel for the Solid applications and 50W and more peak RF power on the 50W channel for the High Resolution applications. Also, it is provided with a mechanical RF relay to ensure HPLNA compatibility output routing, see more in <u>"Output Routing Block Diagram" on page 20</u>.

The amplifier is equipped with **N-Channel RF LDMOSFETs** transistors of the latest generation. The unit can provide full power for any combination of pulse width and duty cycle up to 100ms and 20% in High Resolution mode and 10% in Solid mode.

Its built-in protection circuitry will allow lower power pulses for longer pulse widths and duty-cycles, maintaining a 50W average power for the Solid application and a 10W average power for the High Resolution application on MAIN OUT or AUX OUT outputs.

The electronic protection circuitry has been designed to protect against:

- Excessive power output level (overdrive)
- Excessive pulse repetition rate (over duty-cycle protection)
- Excessive pulse duration (over pulse-width)
- More than 50% reflected RF power (mismatch when VSWR ≥ 6)
- Thermal protection (overheat)

The amplifier is powered by an internal switched power supply assembly that provides the +32VDC for the power amplifiers, in addition to all low level voltages for the system.

The supply is self protected for overcurrent and overvoltage.

The entire unit is housed in a 19", 3U, 520mm rack cabinet.

# **General Information**

Safety 2



The BLAH500 E Amplifier 500-600MHz is in accordance with the standard 61010-1 and with the UL 61010-1 / CSA C22.2 No.61010-1-04 Safety Requirements for Electrical Equipments.

#### Identification Labels 2.1

Labels are provided to alert operating and service personnel to conditions that may cause personal injury or damage to the equipment from misuse or abuse. Please read the labels and understand their meaning.

Identifying Plate 2.1.1

The BLAH500 E Amplifier 500-600MHz can be identified by an identifying plate at the front panel of the unit that contains the following information :

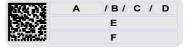


Figure 2.1. Identifying Plate

#### • (A) Part Number

This field indicates the part number of the product.

#### • (B) Variant

This field indicates the variant number that identifies the production category of the product. The default variant is 00.

#### • (C) ECL

This field indicates the revision number that identifies the product configuration. The initial revision is 0.00.

#### • (D) Serial Number

This field indicates the serial number of the product.

#### (E) Type

This field contains the designation of the product.

#### • (F) Information

This field contains additional information about the product.

The BLAH500 E Amplifier 500-600MHz can be identified by a manufacturer's name plate at the back panel of the unit that contains the following information :

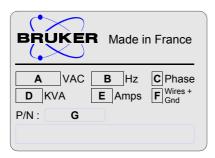


Figure 2.2. Manufacturer's Name Plate

#### (A) Voltage

This field indicates the input mains voltage of the product.

#### • (B) Frequency

This field indicates the input mains frequency of the product.

#### (C) Phases

This field indicates the number of phases of the mains.

#### • (D) Power

This field indicates the absorbed power of the product.

#### • (E) Current

This field indicates the absorbed current of the product.

#### • (F) Wires

This field indicates number of wires with the ground in the mains cord.

#### • (G) Part Number

This field indicates the assembly number that identifies the part number of the product.

#### Safety Labels and Symbols

2.2

### Warning Signs 2.2.1

#### Danger



#### **DANGER!** Risk of electrical shocks

Throughout this manual, this symbol indicates the possibility of severe personal injury, loss of life or equipment damage if the instructions are not followed.

On the equipment, the symbol also implies a danger and alerts the user.

#### Instruction

Operating personal should not remove RF output cable without turn off the power supply because the RF output can cause serious burns before the "Mismatch" protection is active.

Please disconnect the mains supply before opening to prevent potential hazard such as :

- Electrical shock from power supply
- Contact burns from the RF module and heatsink
- Finger scratch due to the fan assembly on the RF module.

# Safety

Installation

The installation of the device must be done only by an authorized and qualified technician, in total accordance with the running standards.

BRUKER BIOSPIN assumes no liability for the customer's failure to comply with these requirements and is therefore not responsible or liable for any injury or damage that occurs as a consequence of non-approved installation.

Initial Inspection 3.1

Mechanical Check 3.1.1

If damage of the shipping cardboard is evident, request the carrier's agent to be present when the instrument is unpacked. Check the equipment for damage and inspect the cabinet and panel surfaces for dents and scratches.

Claim for Damage 3.1.2

If the unit is mechanically damaged or fails to meet specifications upon receipt, notify BRUKER or our representative immediately. Retain the shipping cardboard and packing material for the carriers inspection as well as for subsequent use in returning the unit if necessary.

### Reshipment and Repackaging Requirements

3.1.3

Whenever possible, the original cardboard and packing material should be used for reshipment. If the original packing material is not available, wrap the instrument in heavy paper or plastic. Use a strong shipping container. If cardboard is used, it should be at least 200 lbs. test material.

Use shock absorbing material around all sides of the instrument to provide a firm cushion and to prevent movement from inside the container wall on each side. Protect the front panel by means of cardboard spacers inserted between the front panel and the shipping cardboard. Make sure that the instrument cannot move in the container during shipping. Seal the cardboard box with a good grade of shipping tape and mark the container:

#### "FRAGILE ELECTRONIC INSTRUMENT"

#### **Environment Requirements**

3.1.4

This amplifier is built for inside use only on a maximum elevation of 2000m above sea level (6600 feet).

No specific cooling or ventilation is required.

Be sure that the amplifier has enough area around it so that the free airs flow into and out of the amplifier is not obstructed.

It should, however, be in an environment which conforms to the 5°C - 45°C (41°F - 113°F) thermal specifications, a 80% maximum relative humidity of air and a contamination level of two (means a normal non-conductive contamination, temporary conductivity due to condensation is possible).

#### Installation Requirements

3.2

No special precautions are necessary. Mount the equipment in an area which is relatively free of vibration, and has sufficient room for cable connections.

The amplifier has a class II installation category.

#### **Bench Operation**

3.2.1

The unit can be placed onto a secure flat surface.

#### **Power Requirements**

3.3

The BLAH500 E Amplifier 500-600MHz has a built-in switched power supply. The mains line connector on the rear panel is a CEI 10A.

#### One Phase Line requirements:

AC input voltage : 208-230VAC

Input current max : 3,4A Frequency : 50/60Hz

## System Check

3.4

Before applying power for the first time the following items should be checked:

- The AC input voltage 208-230 VAC ± 10% range must be compatible with the power supply.
- An external blanking (gating) pulse must be supplied to the amplifier in order for the unit to function. Ensure that this pulse has a proper level and logic polarity.
- The BLAH500 E Amplifier 500-600MHz has a nominal input level of +4dBm.
   Ensure that the system drivers are operating at these levels.
- Output RF loads are connected.

#### Initial Turn on Procedure

3.5

The following list describes how to turn on the BLAH500 E Amplifier 500-600MHz and what should be seen as this occurs.

Before starting this procedure, make sure that you have properly followed the instructions in section <u>"System Check" on page 12</u>.

- 1. Connect the amplifier to the AC line and turn the line switch to ON.
- 2. Observe the indicators on the front panel of the amplifier:
  - The +32V ON LED's will illuminate,
  - The +15V, -15V and +3,3V ON LED's will illuminate.
- 3. System is now fully operational.

# Installation

# **Operation**

# Front Panel Description

4.1

The BLAH500 E Amplifier 500-600MHz front panel is provided with 13 indicators for status monitoring, 7 RF connectors, 1 interface connector and 1 line switch.

Indicators 4.1.1

Normal operation is indicated when following LED's are ON.

Table 4.1. Indicators Assignment

+32V	Indicates that the +32V supply is applied.
+15V	Indicates that the +15V supply is applied.
-15V	Indicates that the -15V supply is applied.
+3,3V	Indicates that the +3,3V supply is applied.
Overdrive	Indicates when the peak power limit has been reached.
Duty Cycle (D.C.)	Indicates when the duty cycle limit has been reached.
Pulse Width (P.W.)	Indicates when the pulse width limit has been reached.
Mismatch	Indicates when the max. reflected power limit has been reached.
RF POW. FLT	Indicates when one of the above limits has been reached.
Overheat	Indicates that the thermistor located on the RF module heatsink has sensed excessive heatsink temperature. The amplifier is blanked until an accepable temperature is reached. The function is self-resetting and no maintenance is needed.  Indicates also that a fan on the assembly stops turning. The amplifier is blanked until fans are changed.
RF PULSE	Indicates when RF Power is present on one of the RF Output connectors.
MAIN OUT	ON indicates that the MAIN OUT 500W/50W is active. OFF indicates that the AUX OUT 500W/50W is active.
500W ON	ON indicates that the 500W channel is active. OFF indicates that the 50W channel is active.

Coaxial Connectors 4.1.2

Table 4.2. Coaxial Connectors Assignment

IN1, IN2, IN3	RF input of the embedded router, SMA type connector (female).  Defaults entry is IN1 and allows to the BLAH500 E to deliver full power at nominal +4dBm drive.
MAIN OUT 500W/50W	RF output if MAIN OUT LED is on, N type connector (female). Default setting that allows High Resolution or Solid application based on the SEL H500/H50 selection.
AUX OUT 500W/50W	RF output if MAIN OUT LED is off, N type connector (female). Available by setting the output router that allows High Resolution or Solid application based on the SEL H500/H50 selection.
BLNK	Blanking input, BNC type connector (female). TTL logic, 5V = blanking ON, 0V = blanking OFF. When BLANKING signal is at TTL level high (+5V), no gating is applied to the amplifier stages, and no RF Power is possible. When BLANKING signal is at TTL level low (0V), the amplifier stages are gated and RF Power is possible.
SEL H500/H50	Select input, BNC type connector (female). When the SEL H500/H50 signal is at TTL level low (0V), the 500W channel for Solid application is selected. When the SEL H500/H50 signal is at TTL level high (+5V), the 50W channel for High Resolution application is selected.

#### Ethernet 10/100 Interface Connector

4.1.3

The RJ45 connector for the Ethernet 10/100 Mbps link is mounted directly on the BLA Control Board.

Table 4.3. RJ45 Pin Assignment

Pin 1	Transmit + (Tx+)
Pin 2	Transmit - (Tx-)
Pin 3	Receive + (Rx+)
Pin 4	N/A
Pin 5	N/A
Pin 6	Receive - (Rx-)
Pin 7	N/A
Pin 8	N/A

Device Front View 4.1.4

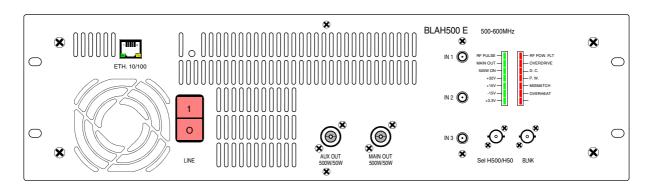


Figure 4.1. BLAH500 E Amplifier 500-600MHz Front Panel Design



Figure 4.2. BLAH500 E Amplifier 500-600MHz Front Panel View

The BLAH500 E Amplifier 500-600MHz rear panel is free of elements in exception of the 3 poles (2P+E) line filter socket.

Device Rear View 4.2.1

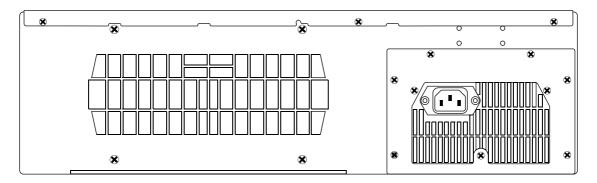


Figure 4.3. BLAH500 E Amplifier 500-600MHz Rear Panel Design



Figure 4.4. BLAH500 E Amplifier 500-600MHz Rear Panel View

System Overview 5.1

The BLAH500 E Amplifier 500-600MHz provides:

- A RF Output of 500W and more for the Solid applications. This high power channel can be put out on the MAIN OUT or the AUX OUT in function of the Topspin selection.
- A RF Output of 50W and more for the High Resolution applications. This low power channel can be put out on the MAIN OUT or the AUX OUT in function of the Topspin selection.

The RF section of the system consists of an embedded router fixed on the front panel and a linear module BLMH500/50-E mounted around a single self-contained Push fan assembly heatsink and a mechanical output router.

The embedded router has three RF inputs and one RF output feeded to the driver amplifier located on the BLMH500/50-E module.

A linear class A / AB driver using switches and bias voltage gatings, delivers the RF input power to the power amplifier. This driver is located on the top of the heatsink assembly.

The class AB power amplifier is located on the bottom of the heatsink assembly.

The selection of the 500W channel or the 50W channel is made with a pair of RF power relays controlled by the SEL H500/H50 input signal.

The output of the power amplifier and the driver are connected via a mechanical relay to a bi-directional high dynamic coupler.

Then the RF power passes through the output router made with a RF power relay. The selection of the MAIN OUT 500W/50W or the AUX OUT 500W/50W is done with a software command from Topspin.

The entire system is controlled by a Digital Signal Processing control board, processing information from the amplifier and blanking signal, providing protection from excessive peak power, duty cycle and pulse width for average power, maximum reflected power and heatsink over-temperature.

The DSP control board reads the identification information of the amplifier (BIS).

Monitoring of fan status, supply status and LED's status is also performed by the control board.

Circuits such as BLAC6 Extension Board 1 Channel and Status LED's board, complete the amplifier assembly.

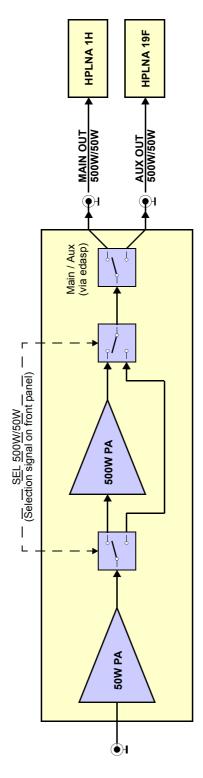


Figure 5.1. Output Routing Block Diagram

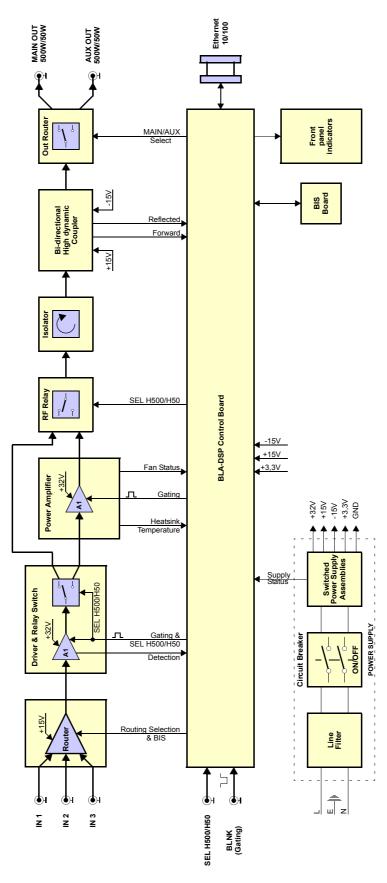


Figure 5.2. BLAH500 E Amplifier 500-600MHz System Block Diagram

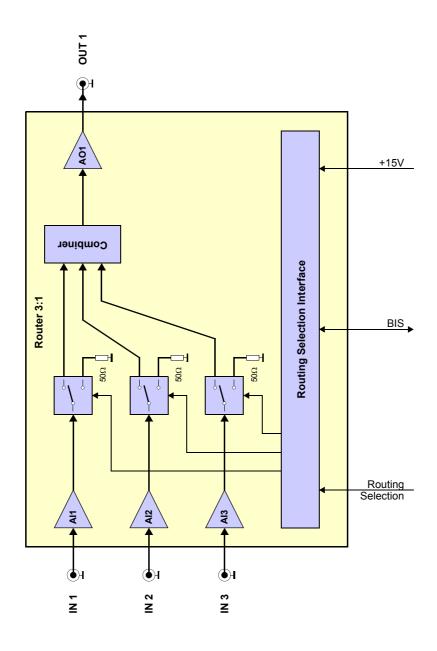


Figure 5.3. Embedded Router Block Diagram

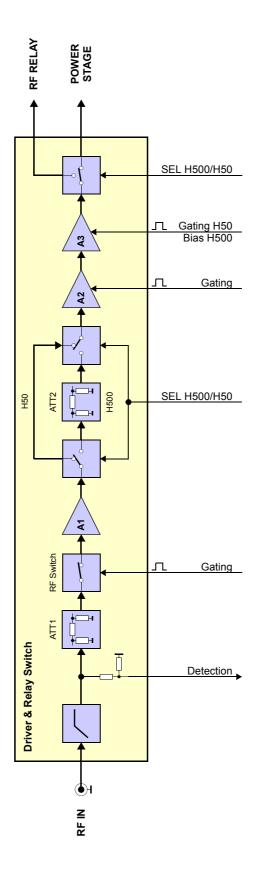


Figure 5.4. Driver & Relay Switch Block Diagram

5.2

RF Path 5.2.1

The BLAH500 E Amplifier 500-600MHz (P/N: W1345527) consists of a 3 input embedded router, a class A / AB driver amplifier, a class AB power amplifier, a bi-directional high dynamic coupler and a mechanical 2 output embedded router.

A nominal input power level of +4dBm produces a rated linear output power of :

- 50W peak for 20% duty cycle at 100ms pulse width maximum on the High Resolution channel 50W when selected. In this case, the 50W driver is directly switched to the high dynamic coupler and the output router via a pair of mechanical relays.
- 500W peak for 10% duty cycle at 100ms pulse width maximum on the Solid channel 500W when selected. In this case, the 50W driver is switched to the input of the 500W power stage via a mechanical relay.

The unit is also capable of longer pulses for lower average power, up to 50W CW power on the 500W channel for Solid application and 10W CW power on the 50W channel for High Resolution application.

### Embedded Input Router

The embedded router consists of a class A RF amplifier IC's and RF switches, manufactured on a Gallium Arsenide process.

It is built on a four independent cells architecture with three RF input cells and one output cell. The RF input cells ensure function of amplification and routing, the output cell ensures the functions of combining, RF amplitude thermo-stability and amplification.

The three RF inputs could be routed alone or combined each other to the RF output by selecting the wished RF path through the BLA controller board. Each entire RF path has a nominal 15dB of gain and operates at +15VDC.

Also, the router is equipped with an EEPROM for BIS information.

#### RF Driver

In the first section of the driver, the RF input signal is fed through a 5 poles high pass filter and the RF detection path. Then, via a thermal PAD attenuator and a GaAs RF switch, the RF signal is convoyed to a hybrid amplifier.

In this section, the GaAs RF switch requires a control board conditioned gating signal to control the operation of the switching element.

A commutable H500/H50 attenuator follows the hybrid amplifier.

This attenuator is built of two GaAs RF switches, commutated by a control board conditioned signal SEL H500/H50 and a thermo-compensated attenuator for compensation of the output power drift with temperature of the amplifier when the 500W channel for Solid application is selected.

This commutable attenuator is needed to minimize gain of about 5dB when the amplifier is operating in Solid application and provides full gain in High Resolution application. It is divided in variable resistive attenuator to adjust output power and the Thermal PAD.

The second section of the driver includes a class AB MOSFET transistor followed by a class AB LDMOSFET transistor.

The polarization of these transistors require a control board conditioned gating signal to control the bias voltage on the gate of the FETs and depends of the selection H500/H50 to prevent the increasing of anti-droop behaviour. If the 500W channel is selected, the gating signal is unblanked else if the 50W channel is selected, it is blanked.

The circuitry around the transistors consists of complementary input and output transformers and baluns and operates the device in Push-Pull.

The RF driver has a nominal 25 to 30dB gain and operates at +32VDC.

With the embedded router gain, the entire path has a nominal 45dB gain in 50W mode for High Resolution operation and 40dB gain to drive the 500W power amplifier stage for Solid operation.

#### RF Relays H500/H50 Selection

The selection or not of the 500W power amplifier is made by a pair of RF mechanical relays, one placed before the power amplifier and the other after.

In case of 50W operation, the pair of relays straps the power amplifier to deliver the 50W RF power directly to the bi-directional high dynamic coupler when the SEL H500/H50 signal is controlled at TTL level high or not connected.

In case of 500W operation, the pair of relays passes the RF power from the driver to the power amplifier when the SEL H500/H50 signal is controlled at TTL level low, and feeds the power to the same bi-directional high dynamic coupler.

#### RF Power Amplifier

The power amplifier includes four class AB LDMOSFET transistors mounted on a single flange. They are coupled with -6dB four ways splitter/combiner to built a nominal 16dB gain and operates at +32VDC. The power amplifier requires a control board conditioned gating signal to control the bias voltage on the gate of the FETs.

#### RF Coupler

The bi-directional high dynamic coupler provides an approximate coupling of 1V peak DC signal for full 500W or 50W depending of the SEL H500/H50 signal, and also a peak DC signal for the reflected power.

Both signals, forward and reflected, are analyzed by the BLA control board for monitoring and protection setting on the MAIN and AUX outputs.

#### **Output Router**

The output router is made with a mechanical RF relay and is located between the high dynamic coupler and the both RF outputs. This relay achieve the RF power to once or other, MAIN OUT 500W/50W or AUX OUT 500W/50W in function of the software selection from Topspin. See <u>"Output Routing Block Diagram" on page 20</u>.

#### Circulator

The RF circulator is a three-port passive device made of magnets and ferrite material used to control the direction of signal flow in a circuit. In our case, the circulator is used as an isolator and protects the output power transistor from excessive signal reflection.

There is a circulator incorporated at the end of the power amplifier, just before the high dynamic coupler.

BLA Control Board 5.2.2

The BLA Control Board has 3 main functions:

- Conditions the input blanking (BLNK) signal and delivers it to the above mentioned RF Paths.
- 2. Allows Ethernet communication with the workstation.
- 3. Monitor the output characteristics of the amplifier thanks to the DC peak detection of the bi-directional coupler. Electronic circuitry processes the detection information and protect the amplifier from overstress like:
- Forward and reflected peak power

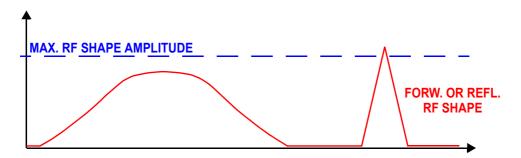


Figure 5.5. Peak Power Limitation

The peak power limitation is the maximum RF forward shape amplitude allowed at the amplifier output.

Limitation range: from 1% to 200% of nominal power.

The peak power limitation is checked for each sample (10 million samples per second), and the maximum peak value is latched then cleared by a read operation (for monitoring purpose).

#### Forward pulse width

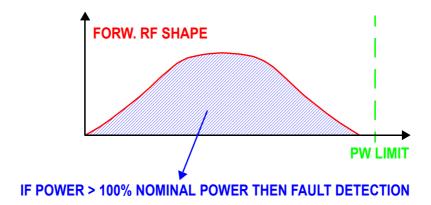


Figure 5.6. Forward Pulse Width Limitation

The pulse width is the lapse of time during which the nominal power can be applied.

Limitation range: from 0.1ms to 512ms.

The pulse width value is updated every 100µs.

Forward pulse duty cycle

The duty cycle value is the ratio between measured input power during pulse width limitation value divided by duty cycle limitation value and the nominal power during the same time.

For example, if the pulse width limitation is set to 3ms and duty cycle is limited to 10%, then duty cycle value equals the measured input power during 30ms (3ms / 0.1) divided by the nominal power during 30ms.

Limitation range: from 1% to 100%.

The duty cycle value is updated every 100µs.

Excess of reflected power (Mismatch)

The mismatch value is the ratio between the reflected power value and the forward power value.

Limitation range: from 1% to 100%.

The mismatch value is updated every 100µs.

Other protections

The control board also detects the following faults:

- Power supply fault
- Fan failure
- Heat sink temperature to protect against thermal overstress
- Fault detection timings

Table 5.1. Fault Detection Timings

Fault	Detection delay (max)
Peak power	500 ns
Duty cycle	100 μs
Pulse Width	100 μs
Mismatch	100 μs
Power Supply, Fan	200 ns
Heat sink temperature	500 ms

Peak, pulse width, duty cycle, mismatch and also mean power values can by read out at any time from the main DSP for monitoring purpose.

- Fault protection reset.

If one of these overstresses appears the board automatically resets the fault flags after 2 seconds, the gating signal is disabled and the status led board on the front panel displays the fault.

This means, for example, that when a pulse width fault occurs, the amplifier channel is disabled after the detection delay. The side effect is that the fault condition disappears since the channel's output power is null.

After 2 seconds, the channel is switched on and the cycle begins again (unless the channel RF input signal is re-adjusted to meet the power limitations).

#### BLA Extension Board 5.2.3

This board gives the information to the control board of RF detection.

### Status Led Board 5.2.4

The status led board, on the front panel of the amplifier, displays overstress functions, supplies status, and so on, as described in <u>"Indicators" on page 15</u> and <u>"BLA Control Board" on page 26</u>.

#### BIS Board 5.2.5

The universal BIS board is located on the amplifier case and contains identifications of the amplifier.



Technical help: please contact your local representative.

# Servicing the BLA

The BLAH500 E Amplifier 500-600MHz provides diagnosis and servicing web pages relies on HTTP, allowing service access with any web browser.

### Accessing the BLA Amplifier

6.1

The BLAH500 E Amplifier 500-600MHz is accessible via the BLA control board with its IP address.

The IP address is given during "**cf**" by using TOPSPIN 2.5x or better software on the workstation.

In case of problems:

- Check the RJ45 cabling between amplifier, Ethernet switch and workstation.
- Check the Ethernet switch power.
- Check if the green LED on the amplifier RJ45 connector lights up.
- Check the front panel of the amplifier, LED's indicators +32V, +15V, -15V and +3.3V ON must have lit.

To access the BLAH500 E Amplifier 500-600MHz, type "ha" in TOPSPIN 2.5x or better and choose the BLA that should be accessed or start your favourite web browser and type the given IP address as URL.

#### Sub Toolbar Information

#### 6.2

#### **Device Information (default)**

6.2.1

You should get the following start screen.

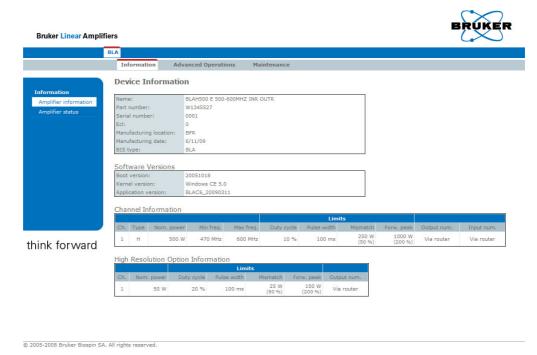


Figure 6.1. Device Information

This page gives you general information about the amplifier (default page).

In the main toolbar, we can see that a BLA is displayed.

The left panel is the navigation menu. It can be used to navigate through the service pages or choose another tab in the sub toolbar.

Amplifier Status 6.2.2

Leads you to a page giving information about the current status of the amplifier.

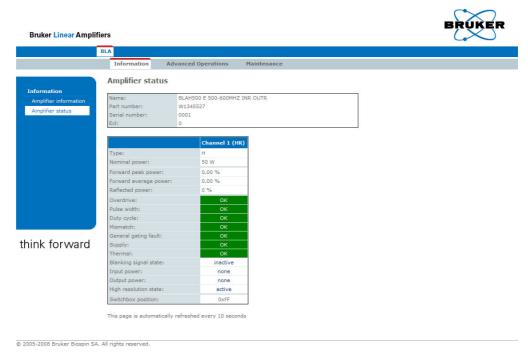


Figure 6.2. Amplifier Status (High Resolution)

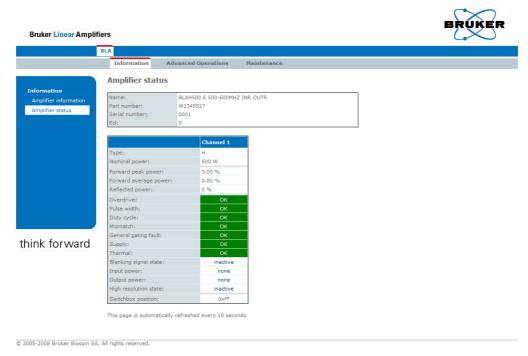


Figure 6.3. Amplifier Status (Solid)

6.3

#### **Device Information (advanced)**

6.3.1

You should get the following start screen.

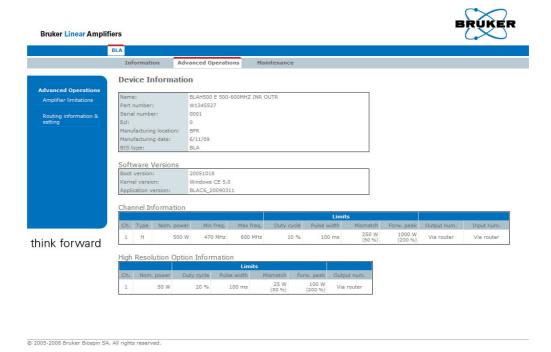


Figure 6.4. Device Information

This page gives you general information about the amplifier.

The left panel is the navigation menu. It can be used to navigate through the service pages or choose another tab in the sub toolbar.

Leads you to a page giving several default and current limits of the amplifier.

If you want, for any reasons, to change the current limits of the amplifier, press *Change limits*.

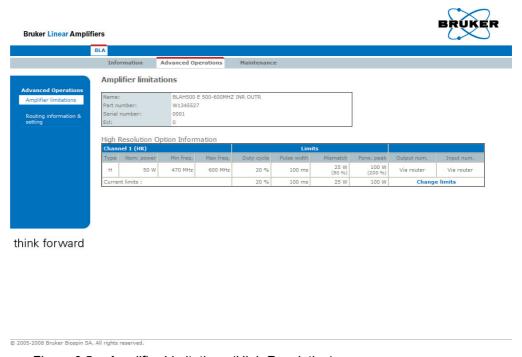


Figure 6.5. Amplifier Limitations (High Resolution)

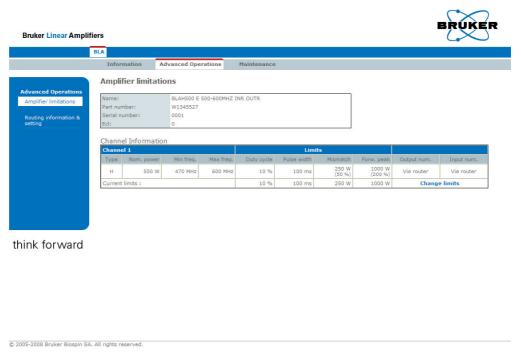


Figure 6.6. Amplifier Limitations (Solid)

Change Limits 6.3.3

Read the warnings, change limit parameters and press *Apply* if you are sure of that.

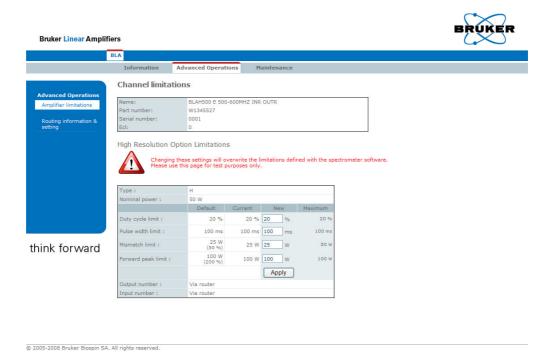


Figure 6.7. Change Limits (High Resolution)

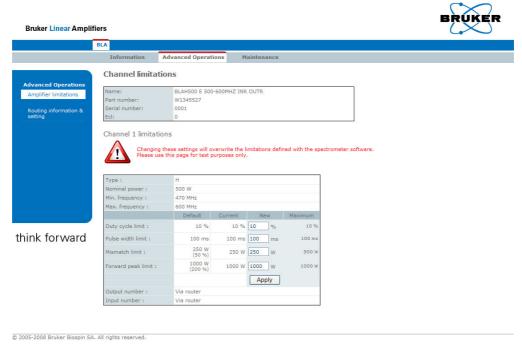


Figure 6.8. Change Limits (Solid)

Leads you to a page giving information about the current routed RF path at the amplifier inputs.

Default RF paths are INPUT 1 to CHANNEL 1 and OUTPUT 1 to CHANNEL 1.

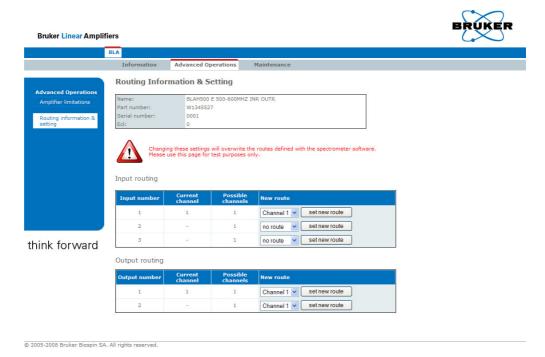


Figure 6.9. Routing Information and Setting

Read the warnings, it is allowed to change routing configuration of the input router and the output router (ex: new route INPUT 2 to CHANNEL 1 or new route OUTPUT 2 to CHANNEL 1), press **set new route** if you are sure of that.

#### Sub Toolbar Maintenance

#### 6.4

#### Device Information (maintenance)

6.4.1

You should get the following start screen.

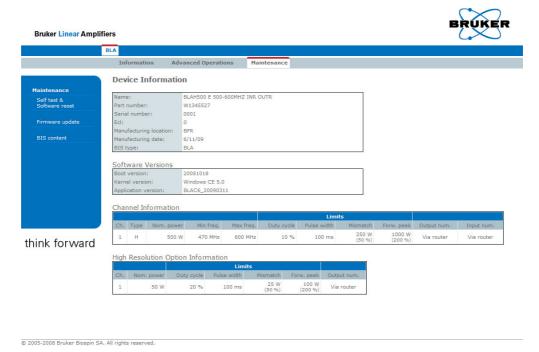


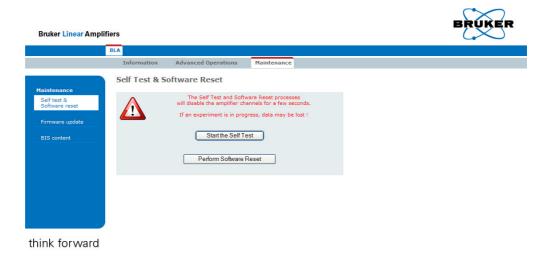
Figure 6.10. Device Information

This page gives you general information about the amplifier.

The left panel is the navigation menu. It can be used to navigate through the service pages or choose another tab in the sub toolbar.

Leads you to a page allowing you to do a self-test on the BLA control board (Hardware test) and to do a software reset.

Both operations can be done if the amplifier doesn't work correctly.



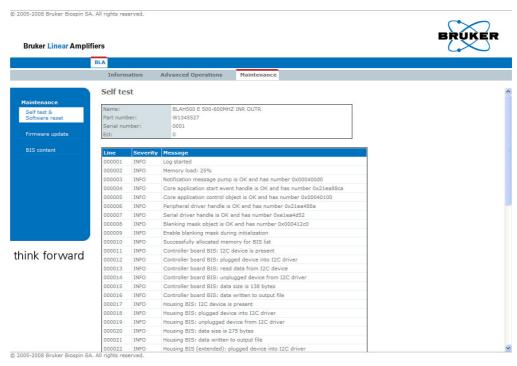


Figure 6.11. Perform Self Test and Report

Read the warnings, press Start the Self Test.

You should have only gray lines in the report.

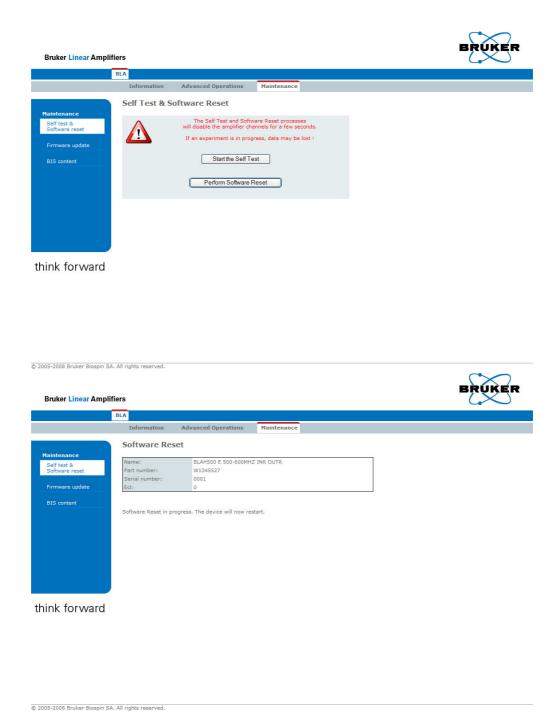


Figure 6.12. Perform Software Reset and Report

Read the warnings, press Perform Software Reset.

You should have the following screen.

Firmware Update 6.4.3

Leads you to a page allowing you to download new firmware.

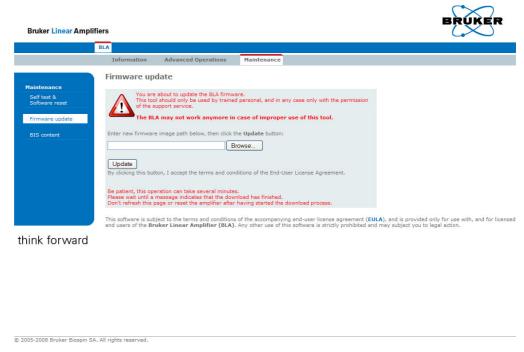


Figure 6.13. Firmware Update

Read the warnings, press the **Browse** button for selecting the new firmware file to download and press **Update**. Download the new firmware will take a few minutes.



NOTE: This button caption depends on your operating system language settings.

BIS Content 6.4.4

Leads you to a page giving information about the current BIS programmed on the amplifier.

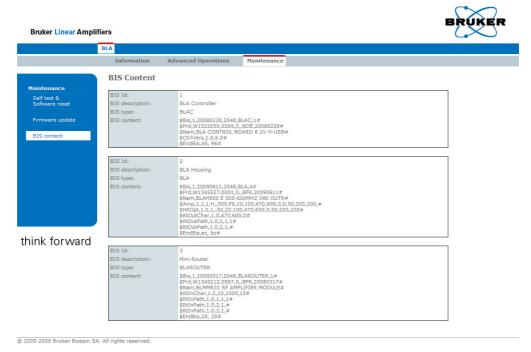


Figure 6.14. BIS Content

# Specifications

#### **Common Characteristics**

7.1

Table 7.1. Amplifier Common Characteristics

Constant Internal Protection	Supplies, fans faults and over temperature. Forward Power: peak & CW power, pulse width and duty cycle. Reflected Power: peak & CW power, self resetting protection shuts the amplifier off if the load VSWR is excessive.	
Front Panel Indicators	Amplifier Status Led Board.	
Front Panel Interfaces	1 x I/O 8 pins RJ45 connector.	
Front Panel Controls	1 x AC line ON/OFF switch, 1 x SEL H500/H50 control signal.	
Front Panel Connectors	3 x RF input, 2 x RF output, 1 x blanking input (gating).	
Rear Panel Connectors	1 x AC line in socket.	
Cooling System	Forced-air cooling (from front to rear).	
Size	19" rack cabinet x 3U height x 520mm depth.	
Weight	19kg	
Power Requirements	208-230 VAC ± 10% single phase 50-60Hz. Bruker Biospin part number W1304006. Consumption max. 0.78kVA.	

#### **General Specifications**

#### 7.2

#### Channel High Resolution 50W Output

7.2.1

Table 7.2. Channel High Resolution 50W Output Specifications

Frequency Range	470 to 600MHz		
Linear Gain 45dB ±1dB typical			
Gain Flatness	±1.5dB max.		
Minimum Pulsed Output Power (@ nominal Input +4dBm)	50W min. full range		
CW Output Power (Internal Limitation)	10W max.		
Linear Output Power	45W typical @ 1dB compression		
Linearity	±1dB to 45W typical		
Amplifier Biasing	Class AB operation		
Blanking Delay Time	1μs min.		
RF Rise Time	< 100ns		
RF Fall Time	< 50ns		
DC Ringing	±100mV typical (due to blanking signal)		
Input Noise Figure	8dB typical		
Output Noise Power (Unblanked)	-123dBm @ 1Hz		
Output Noise Power (Blanked)	Thermal Noise		
Input/Output Impedance	50Ω		
Input V.S.W.R. Route OFF	1.6 : 1 max.		
Input V.S.W.R. Route ON	1.5 : 1 max.		
Output Harmonics (2fc; 3fc)	-45dBc ; -70dBc max. @ 50W		
Pulse Width (Internal Limitation)	100ms @ 50W (up to CW @ 10W)		
Duty Cycle (Internal Limitation)	20% @ 50W (up to 100% @ 10W)		
Droop & Pulse Flatness ±2% typical @ 50W for 100ms Pulse W			
Amplitude Stability vs. Temperature	±0.1% / °C max.		

Table 7.3. Channel Solid 500W Output Specifications

Frequency Range	470 to 600MHz		
Linear Gain	55dB ±1dB typical		
Gain Flatness	±2dB max.		
Minimum Pulsed Output Power (@ nominal Input +4dBm)	500W min. full range		
CW Output Power (Internal Limitation)	50W max.		
Linear Output Power	500W typical @ 1dB compression		
Linearity	+2dB / -1dB to 500W typical		
Amplifier Biasing	Class AB operation		
Blanking Delay Time	1μs min.		
RF Rise Time	< 100ns		
RF Fall Time	< 50ns		
DC Ringing	±100mV typical (due to blanking signal)		
Input Noise Figure	8dB typical		
Output Noise Power (Unblanked)	-113dBm @ 1Hz		
Output Noise Power (Blanked)	Thermal Noise		
Input/Output Impedance	50Ω		
Input V.S.W.R. Route OFF	1.6 : 1 max.		
Input V.S.W.R. Route ON	1.5 : 1 max.		
Output Harmonics (2fc; 3fc)	-40dBc ; -65dBc max. @ 500W		
Pulse Width (Internal Limitation)	100ms @ 500W (up to CW @ 50W)		
Duty Cycle (Internal Limitation)	10% @ 500W (up to 100% @ 50W)		
Droop & Pulse Flatness	±4% typical @ 500W for 100ms Pulse Width		
Amplitude Stability vs. Temperature	±0.1% / °C max.		

### **Specifications**

# Service Information and Maintenance

Every intervention on the device must be carried out by an authorized and qualified person. Any failure due to a non-respect of the following instructions will not be attributable to BRUKER BIOSPIN and will not be covered by the guarantee clauses.

#### Preventive Maintenance of the RF Module on BLA-Type Amplifiers

8.1

The RF module inside BLA's Amplifiers is equipped with a easily extractible PUSH FAN Assembly.

Fan's on assembly have a high reliability and manufacturer gives a expected live time of 70000 hours (8 years) at 25°C and 5 years at 60°C.

Replacement of the assembly could be done in the field when a misfonction of fans is detected by lightning from the OVERHEAT Status Led.

To prevent such a misfonction, a preventive maintenance could be done every 4 years.

This assembly can be ordered on the manufactory BBIO-FR by P/N:

W1346523 «PUSH FAN ASSEMBLY 6».

#### Operation 8.1.1

- Disconnect all cables from the front panel and the supply connector on the rear panel. Remove the amplifier from the NMR console and place it on a secure flat surface.
- 2. Unscrew and remove the coverage plate from the amplifier.
- Disconnect the 2 wires (red +32V / black GND) being on the RF module dispatch supply connectors and coming from the Push fan assembly. Also disconnect the fan status wires (white) from BLA Control board connector J18.

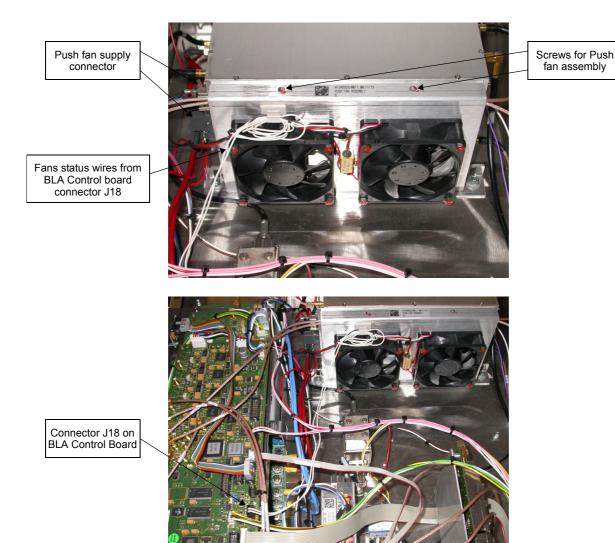


Figure 8.1. Push Fan Assembly

- 4. Unscrew the 2 screws on the top of the Push fan assembly.
- 5. Remove the Push fan assembly.
- 6. Place correctly the new fan assembly in the bottom holes of the RF module and screw it on the top.
- 7. Connect all wires (status and supply).
- 8. Connect line cord and turn on the amplifier. Note that the fans are turning and no OVERHEAT status led appears on front panel.
- 9. Put the coverage plate on the amplifier and screw it.
- 10. Put the amplifier in the NMR console, connect all cables on the front panel and the line cord on the rear panel.

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